



Product Change Notification: SYST-06PLIR111

Date:

13-May-2026

Product Category:

Power Management - Power Switches

Notification Subject:

Data Sheet - MIC9404X Family Data Sheet

Affected CPNs:

[SYST-06PLIR111_Affected_CPN_05132026.pdf](#)

[SYST-06PLIR111_Affected_CPN_05132026.csv](#)

Notification Text:

SYST-06PLIR111

Microchip has released a new Datasheet for the MIC9404X Family Data Sheet of devices. If you are using one of these devices please read the document located at [MIC9404X Family Data Sheet](#).

Notification Status: Final

Description of Change:

APPENDIX A: REVISION HISTORY

Revision B (May 2026)

- Updated the Package Type from FDFN to UDFN throughout the document.
- Updated Package Outline Drawing in Section 5.0 “Packaging Information”.

Revision A (November 2021)

- Converted Micrel document MIC94040/1/2/3 to Microchip data sheet template DS20006607A.
- Minor grammatical text changes throughout.

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

Change Implementation Status: Complete

Date Document Changes Effective: 13 May 2026

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachments:

MIC9404X Family Data Sheet

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

MIC94040YFL-TR

MIC94041YFL-TR

MIC94042YFL-TR

MIC94043YFL-TR

28 mΩ $R_{DS(ON)}$ 3A High-Side Load Switch in 1.2 mm x 1.2 mm UDFN Package

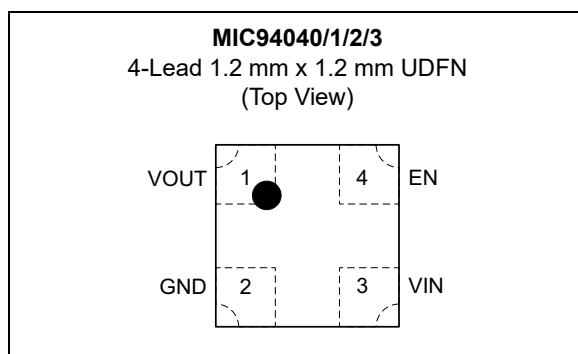
Features

- 28 mΩ $R_{DS(ON)}$
- 3A Continuous Operating Current
- Space-Saving 1.2 mm x 1.2 mm 4-Lead UDFN Package
- Input Voltage Range: 1.7V to 5.5V
- Internal Level Shift for CMOS/TTL Control Logic
- Ultra-Low Quiescent Current
- Micropower Shutdown Current
- Soft-Start: MIC94042, MIC94043
- Load Discharge Circuit: MIC94041, MIC940483
- Ultra-Fast Turn-Off Time
- -40°C to +125°C Junction Operating Temperature

Applications

- Cellular Phones
- Portable Navigation Devices (PND)
- Personal Media Players (PMP)
- Ultra-Mobile PCs
- Portable Instrumentation
- Other Portable Applications
- PDAs
- Industrial and Datacom Equipment

Package Type



General Description

The MIC94040, MIC94041, MIC94042, and MIC94043 are a family of high-side load switches designed to operate from 1.7V to 5.5V input voltage. The load switch pass element is an internal 28 mΩ $R_{DS(ON)}$ P-channel MOSFET which enables the device to support up to 3A of continuous current. Additionally, the load switch supports 1.5V logic level control and shutdown features in a tiny 1.2 mm x 1.2 mm 4-lead UDFN package.

The MIC94040 and MIC94041 feature rapid turn on, while the MIC94042 and MIC94043 provide a slew rate controlled soft-start turn-on of 100 μs. The soft-start feature is provided to prevent an in-rush current event from pulling down the input supply voltage.

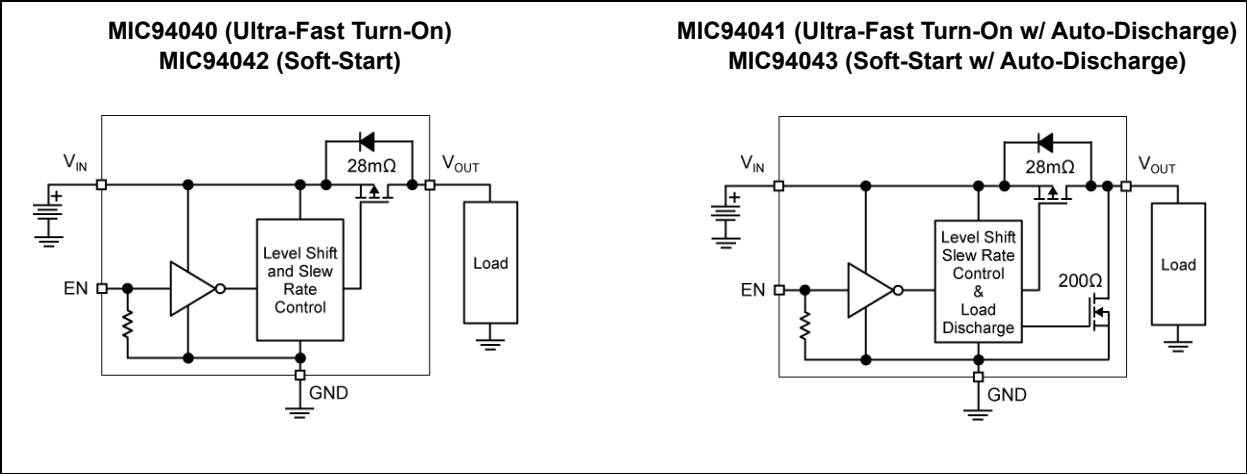
The MIC94041 and MIC94043 feature an active load discharge circuit which switches in a 200Ω load when the switch is disabled to automatically discharge a capacitive load.

An active pull-down on the enable input keeps the MIC94040/1/2/3 in a default OFF state until the enable pin is pulled above 1.2V. Internal level shift circuitry allows low voltage logic signals to switch higher supply voltages. The enable voltage can be as high as 5.5V and is not limited by the input voltage.

The MIC94040/1/2/3 operating voltage range makes them ideal for Lithium ion and NiMH/NiCad/Alkaline battery powered systems, as well as non-battery powered applications. The devices provide low quiescent current and low shutdown current to maximize battery life.

MIC94040/1/2/3

Typical Application Circuits



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Input Voltage (V_{IN})	+6V
Enable Voltage (V_{EN})	+6V
Continuous Drain Current (I_D) (Note 1)	
$T_A = +25^\circ\text{C}$	$\pm 3\text{A}$
$T_A = +85^\circ\text{C}$	$\pm 2\text{A}$
Pulsed Drain Current (I_{DP}) (Note 2)	$\pm 6.0\text{A}$
Continuous Diode Current (I_S) (Note 3)	-50 mA
ESD Rating (HBM, Note 4)	3 kV

Operating Ratings ††

Input Voltage (V_{IN})	+1.7V to +5.5V
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† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

†† **Notice:** The device is not guaranteed to function outside its operating ratings.

Note 1: With thermal contact to PCB. See Thermal Considerations section.

2: Pulse width <300 μs with <2% duty cycle.

3: Continuous body diode current conduction (reverse conduction, i.e. V_{OUT} to V_{IN}) is not recommended.

4: Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5 k Ω in series with 100 pF.

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: $T_A = +25^\circ\text{C}$, **bold** values indicate $-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$, unless noted.

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Enable Threshold Voltage	V_{EN_TH}	0.4	—	1.2	V	$V_{IN} = 1.7\text{V to } 4.5\text{V}$, $I_D = -250 \mu\text{A}$
Quiescent Current	I_Q	—	0.1	1	μA	$V_{IN} = V_{EN} = 5.5\text{V}$, $I_D = \text{OPEN}$ Measured on V_{IN} MIC94040/1
		—	7	10		$V_{IN} = V_{EN} = 5.5\text{V}$, $I_D = \text{OPEN}$ Measured on V_{IN} MIC94042/3
Enable Input Current	I_{EN}	—	2.5	4	μA	$V_{IN} = V_{EN} = 5.5\text{V}$, $I_D = \text{OPEN}$
Quiescent Current (Shutdown)	I_{SHUT-Q}	—	0.1	1	μA	$V_{IN} = +5.5\text{V}$, $V_{EN} = 0\text{V}$, $I_D = \text{OPEN}$ Measured on V_{IN}
OFF State Leakage Current	$I_{SHUT-SWITCH}$	—	0.1	1	μA	$V_{IN} = +5.5\text{V}$, $V_{EN} = 0\text{V}$, $I_D = \text{SHORT}$ Measured on V_{IN} , Note 1
P-Channel Drain-to-Source ON Resistance	$R_{DS(ON)}$	—	28	55	$\text{m}\Omega$	$V_{IN} = +5.0\text{V}$, $I_D = -100 \text{ mA}$, $V_{EN} = 1.5\text{V}$
		—	30	60		$V_{IN} = +4.5\text{V}$, $I_D = -100 \text{ mA}$, $V_{EN} = 1.5\text{V}$
		—	33	65		$V_{IN} = +3.6\text{V}$, $I_D = -100 \text{ mA}$, $V_{EN} = 1.5\text{V}$
		—	45	90		$V_{IN} = +2.5\text{V}$, $I_D = -100 \text{ mA}$, $V_{EN} = 1.5\text{V}$
		—	72	145		$V_{IN} = +1.8\text{V}$, $I_D = -100 \text{ mA}$, $V_{EN} = 1.5\text{V}$
		—	82	160		$V_{IN} = +1.7\text{V}$, $I_D = -100 \text{ mA}$, $V_{EN} = 1.5\text{V}$

Note 1: Measured on the MIC94040YFL and MIC94042YFL.

MIC94040/1/2/3

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: $T_A = +25^\circ\text{C}$, **bold** values indicate $-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$, unless noted.

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Load Discharge Resistance	$R_{\text{DISCHARGE}}$	—	250	400	Ω	$V_{\text{IN}} = +3.6\text{V}$, $I_{\text{TEST}} = 1\text{ mA}$, $V_{\text{EN}} = 0\text{V}$ MIC94041/3
Dynamic Electrical Characteristics						
Turn-On Delay	$t_{\text{ON_DLY}}$	—	0.97	1.5	μs	$V_{\text{IN}} = +3.6\text{V}$, $I_{\text{D}} = -100\text{ mA}$, $V_{\text{EN}} = 1.5\text{V}$ MIC94040, MIC94041
		50	106	185		$V_{\text{IN}} = +3.6\text{V}$, $I_{\text{D}} = -100\text{ mA}$, $V_{\text{EN}} = 1.5\text{V}$ MIC94042, MIC94043
Turn-On Rise Time	$t_{\text{ON_RISE}}$	0.5	0.9	5	μs	$V_{\text{IN}} = +3.6\text{V}$, $I_{\text{D}} = -100\text{ mA}$, $V_{\text{EN}} = 1.5\text{V}$ MIC94040, MIC94041
		50	116	200		$V_{\text{IN}} = +3.6\text{V}$, $I_{\text{D}} = -100\text{ mA}$, $V_{\text{EN}} = 1.5\text{V}$ MIC94042, MIC94043
Turn-Off Delay Time	$t_{\text{OFF_DLY}}$	—	100	200	ns	$V_{\text{IN}} = +3.6\text{V}$, $I_{\text{D}} = -100\text{ mA}$, $V_{\text{EN}} = 0\text{V}$
Turn-Off Fall Time	$t_{\text{OFF_FALL}}$	—	20	100	ns	$V_{\text{IN}} = +3.6\text{V}$, $I_{\text{D}} = -100\text{ mA}$, $V_{\text{EN}} = 0\text{V}$

Note 1: Measured on the MIC94040YFL and MIC94042YFL.

TEMPERATURE SPECIFICATIONS

Parameters	Symbol	Min.	Typ.	Max.	Units	Conditions
Temperature Ranges						
Junction Temperature Range	T_J	-40	—	+125	$^\circ\text{C}$	—
Storage Temperature Range	T_S	-55	—	+150	$^\circ\text{C}$	—
Package Thermal Resistances						
Thermal Resistance, 4-Ld UDFN 1.2 mm x 1.2 mm	θ_{JC}	—	90	—	$^\circ\text{C/W}$	—

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A , T_J , θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum $+125^\circ\text{C}$ rating. Sustained junction temperatures above $+125^\circ\text{C}$ can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

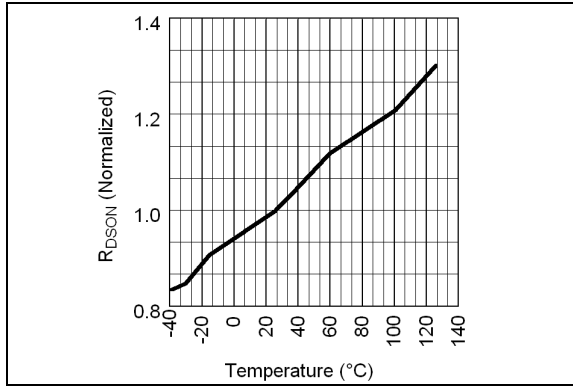


FIGURE 2-1: MIC94040/1/2/3 $R_{DS(ON)}$ Variance vs. Temperature.

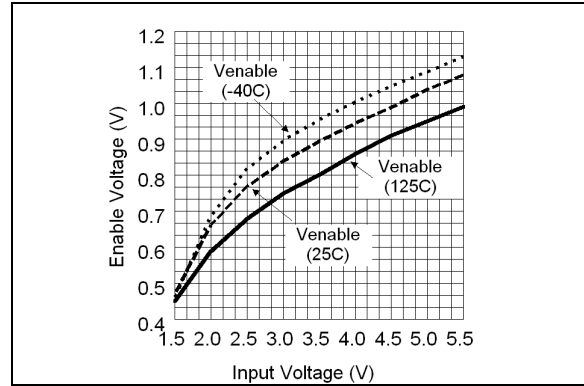


FIGURE 2-4: MIC94040/1 Enable Threshold vs. Input Voltage.

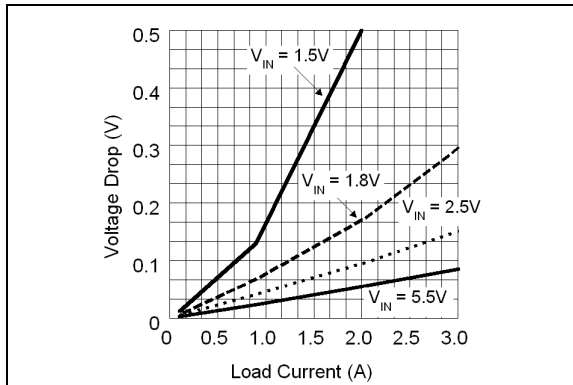


FIGURE 2-2: MIC94040/1/2/3 Voltage Drop vs. Load Current.

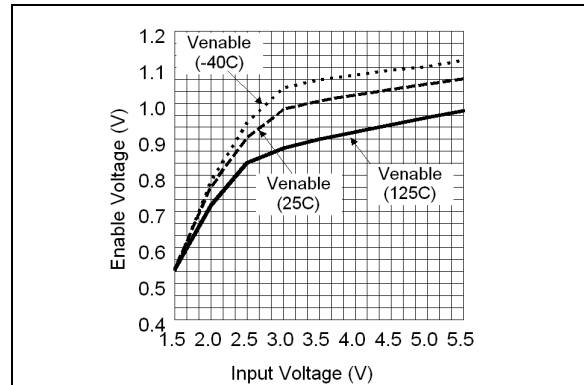


FIGURE 2-5: MIC94042/3 Enable Threshold vs. Input Voltage.

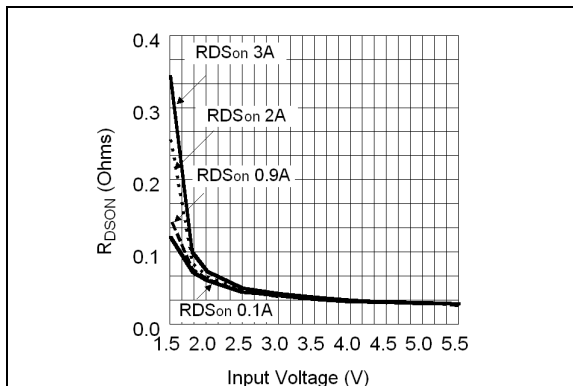


FIGURE 2-3: MIC94040/1/2/3 On Resistance vs. Input Voltage.

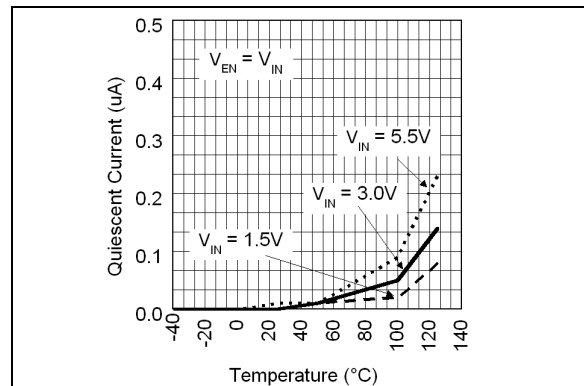


FIGURE 2-6: MIC94040/1 Quiescent Current vs. Temperature.

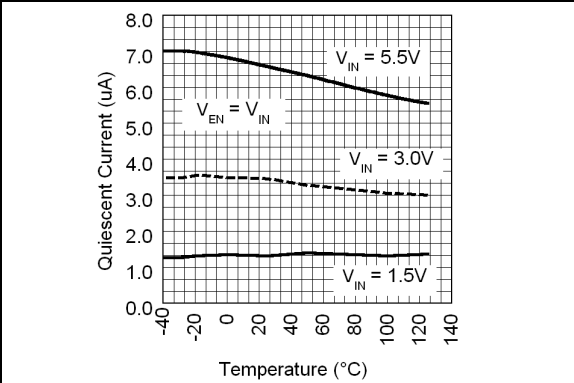


FIGURE 2-7: MIC94042/3 Quiescent Current vs. Temperature.

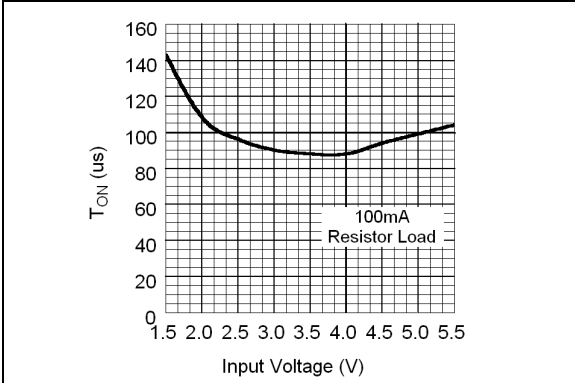


FIGURE 2-10: MIC94042/3 t_{ON} Delay vs. Input Voltage.

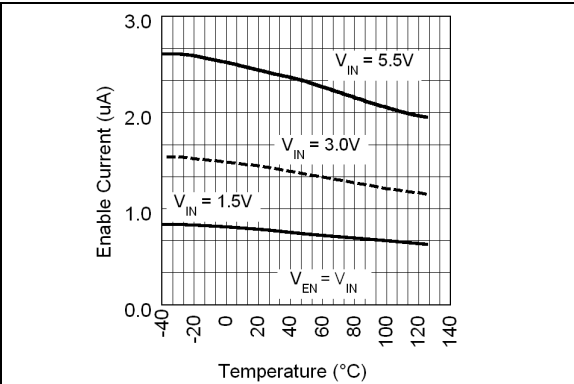


FIGURE 2-8: MIC94042/3 Enable Current vs. Temperature.

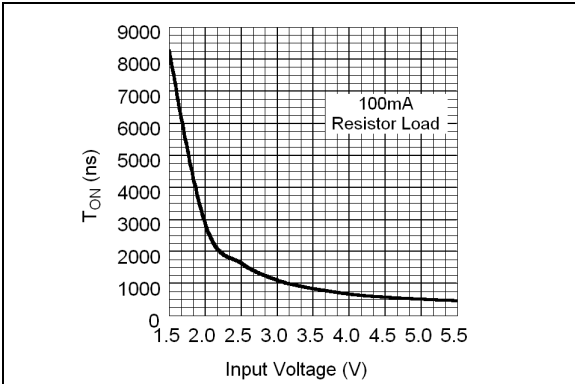


FIGURE 2-11: MIC94040/1 Rise Time vs. Input Voltage.

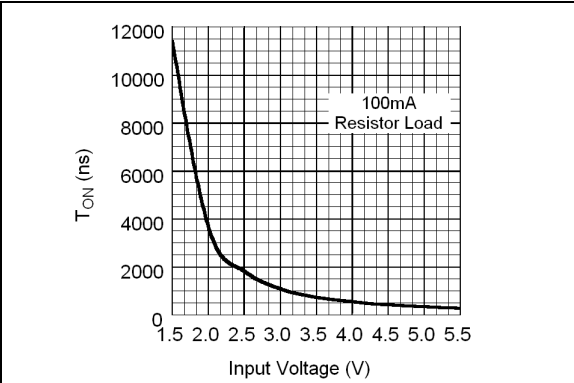


FIGURE 2-9: MIC94040/1 t_{ON} Delay vs. Input Voltage.

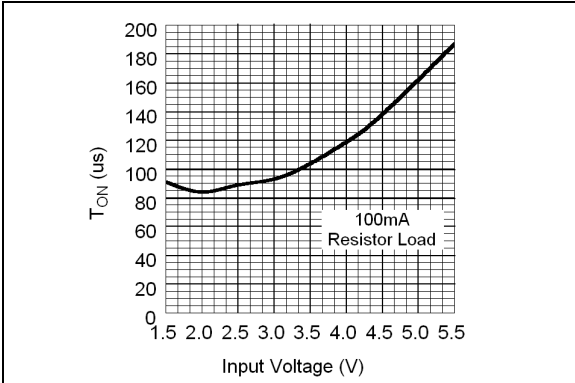


FIGURE 2-12: MIC94042/3 Rise Time vs. Input Voltage.

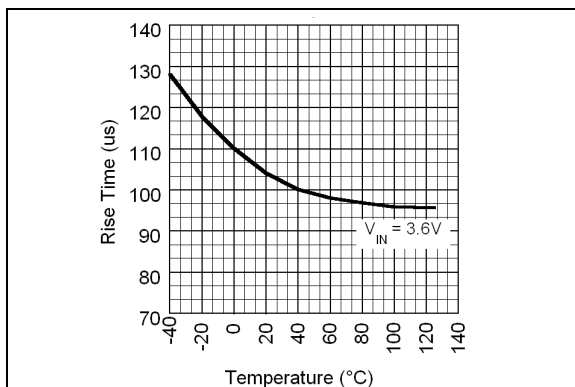


FIGURE 2-13: MIC94040/1 Turn-On Rise Time vs. Temperature.

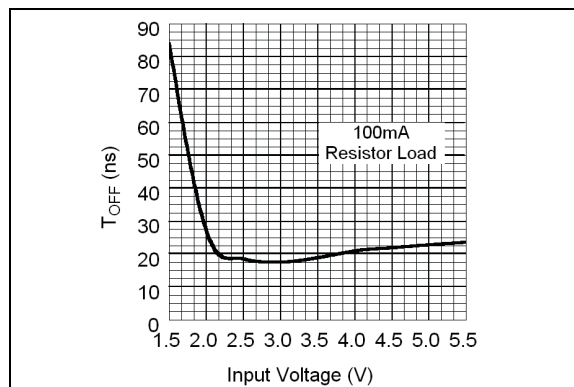


FIGURE 2-16: MIC94042/3 Fall Time vs. Input Voltage.

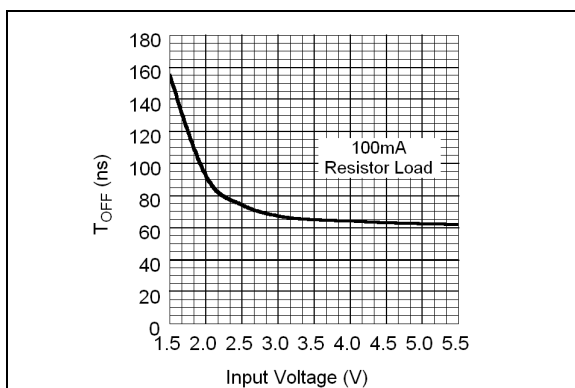


FIGURE 2-14: MIC94042/3 t_{OFF} Delay vs. Input Voltage.

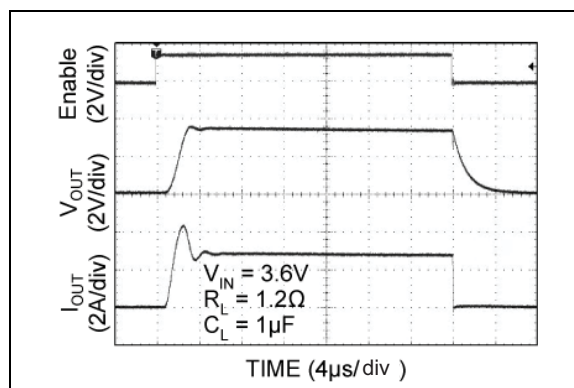


FIGURE 2-17: MIC94040 Turn-On/Turn-Off Timing.

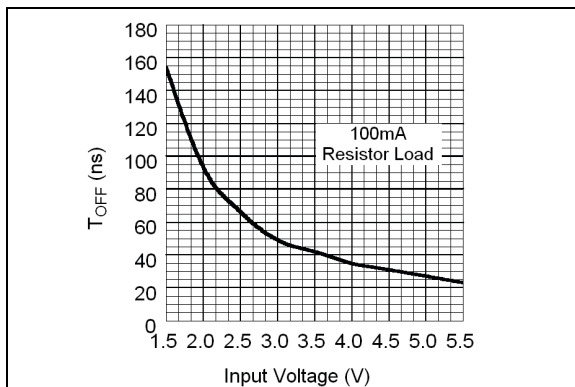


FIGURE 2-15: MIC94040/1/2/3 t_{OFF} Delay vs. Input Voltage.

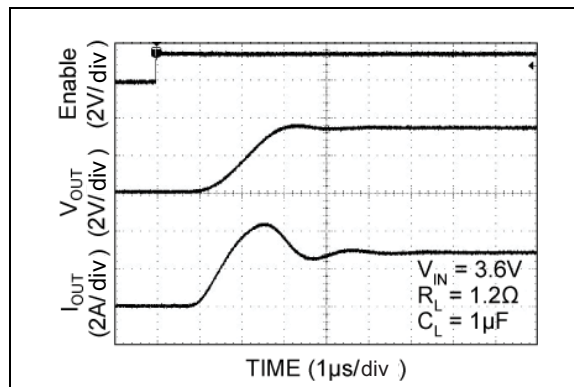


FIGURE 2-18: MIC94040 Turn-On/Turn-Off Timing.

MIC94040/1/2/3

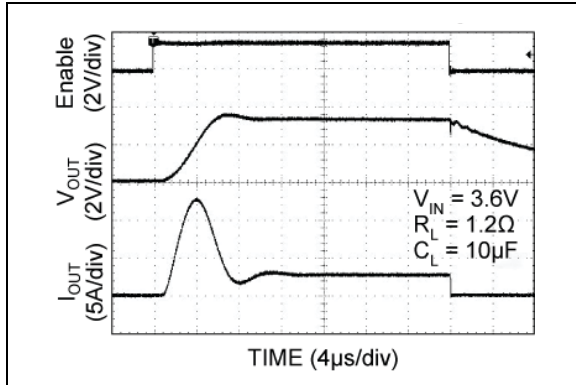


FIGURE 2-19: MIC94040 Turn-On/Turn-Off Timing.

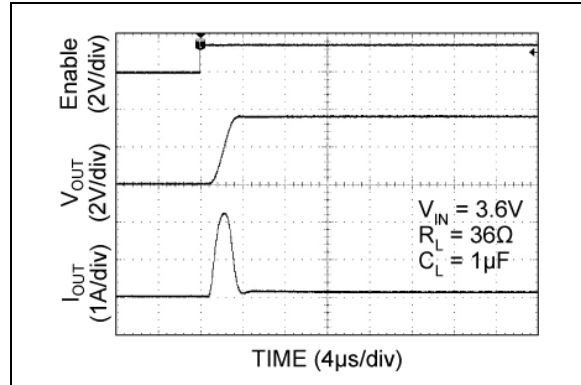


FIGURE 2-22: MIC94040 Turn-On/Turn-Off Timing.

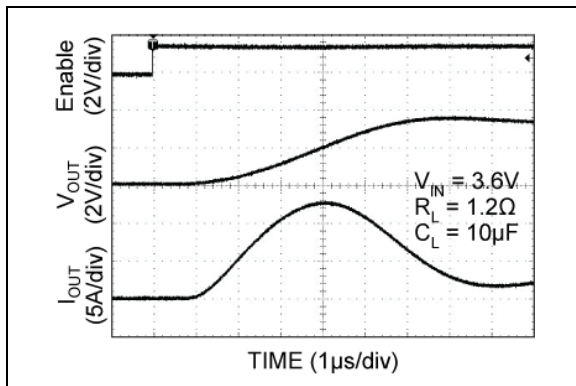


FIGURE 2-20: MIC94040 Turn-On/Turn-Off Timing.

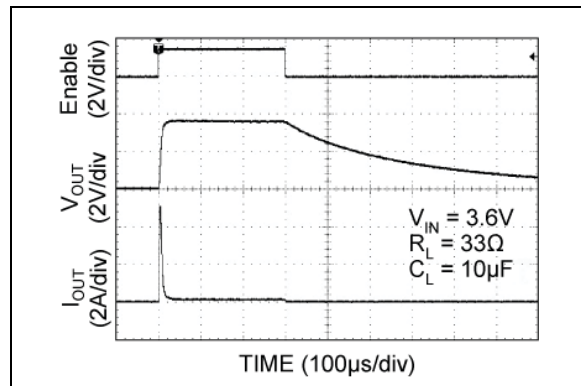


FIGURE 2-23: MIC94040 Turn-On/Turn-Off Timing.

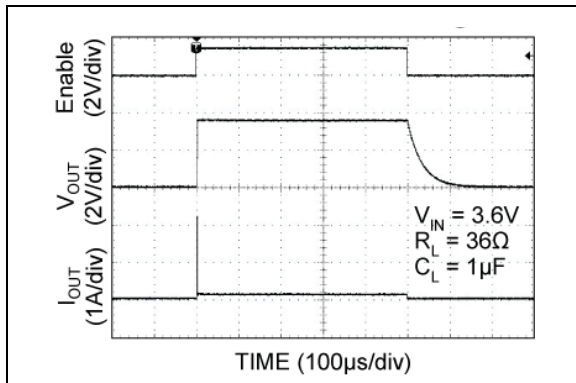


FIGURE 2-21: MIC94040 Turn-On/Turn-Off Timing.

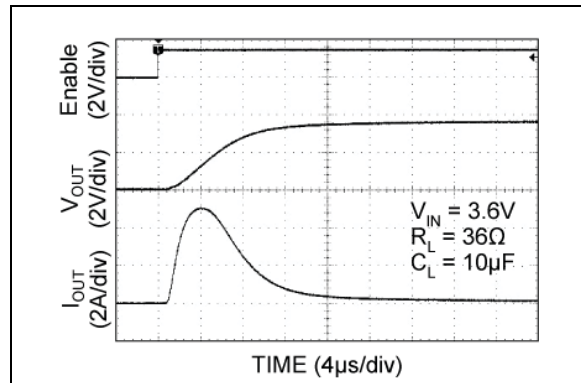


FIGURE 2-24: MIC94040 Turn-On/Turn-Off Timing.

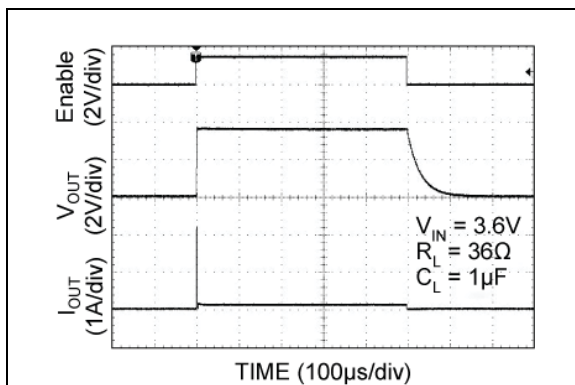


FIGURE 2-25: MIC94041 Turn-On/Turn-Off Timing.

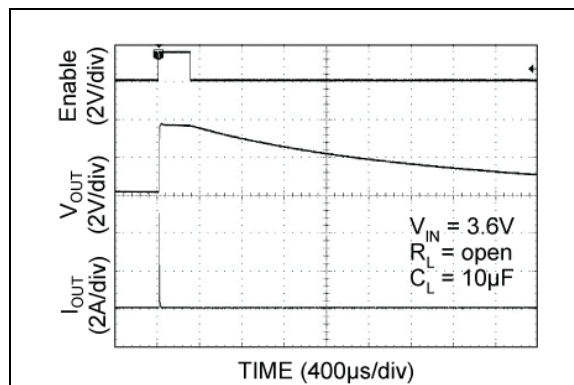


FIGURE 2-28: MIC94041 Turn-On/Turn-Off Timing.

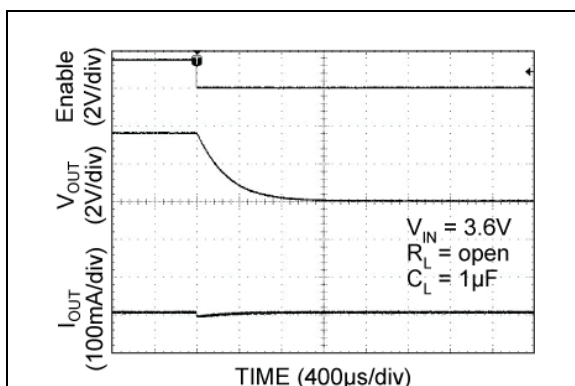


FIGURE 2-26: MIC94041 Turn-On/Turn-Off Timing.

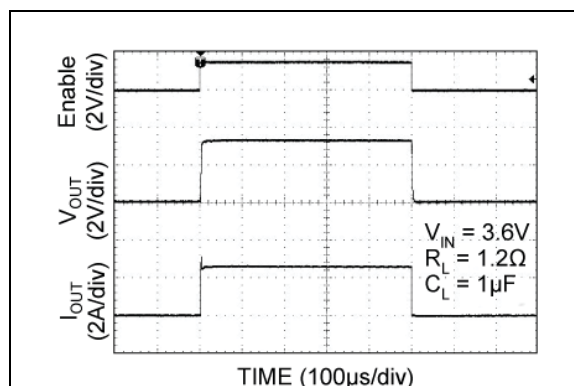


FIGURE 2-29: MIC94041 Turn-On/Turn-Off Timing.

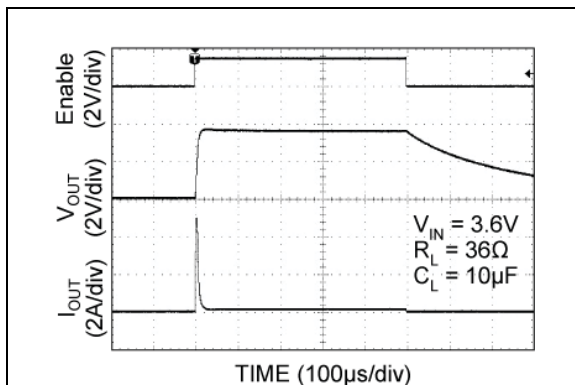


FIGURE 2-27: MIC94041 Turn-On/Turn-Off Timing.

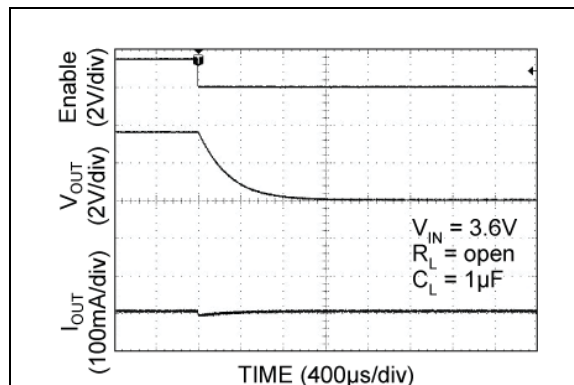


FIGURE 2-30: MIC94041 Turn-On/Turn-Off Timing.

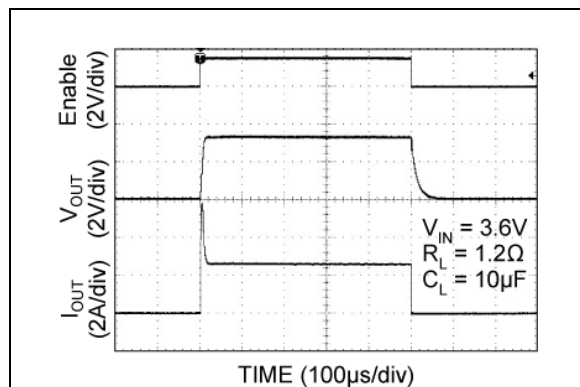


FIGURE 2-31: MIC94041 Turn-On/Turn-Off Timing.

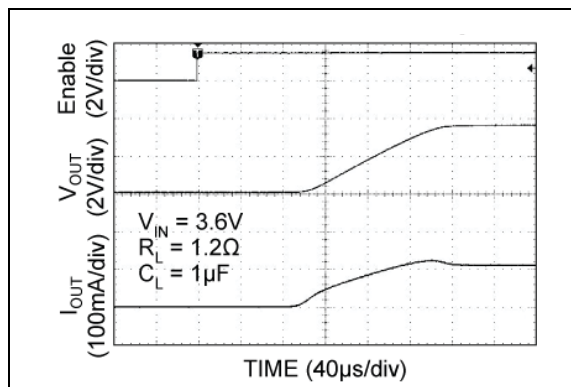


FIGURE 2-34: MIC94042 Turn-On/Turn-Off Timing.

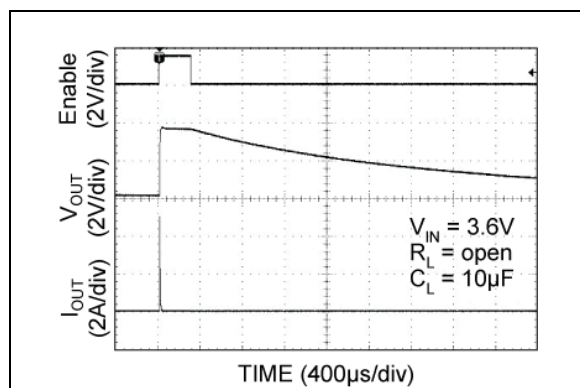


FIGURE 2-32: MIC94041 Turn-On/Turn-Off Timing.

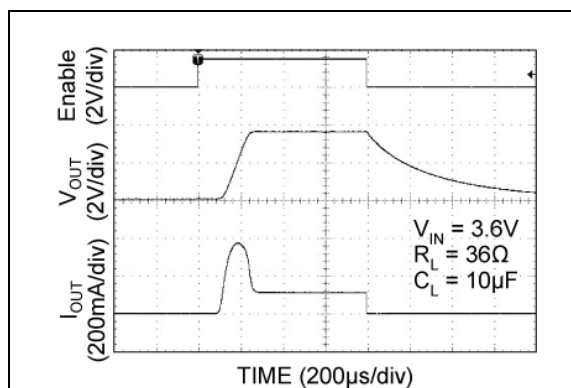


FIGURE 2-35: MIC94042 Turn-On/Turn-Off Timing.

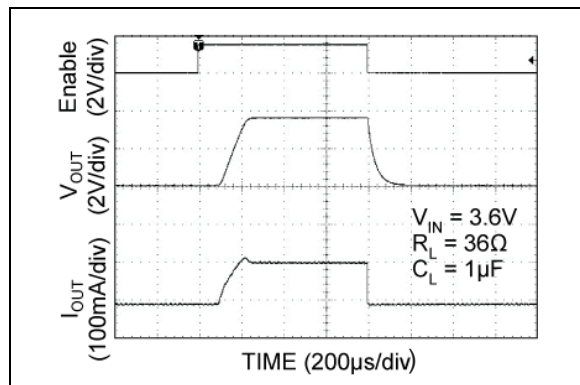


FIGURE 2-33: MIC94042 Turn-On/Turn-Off Timing.

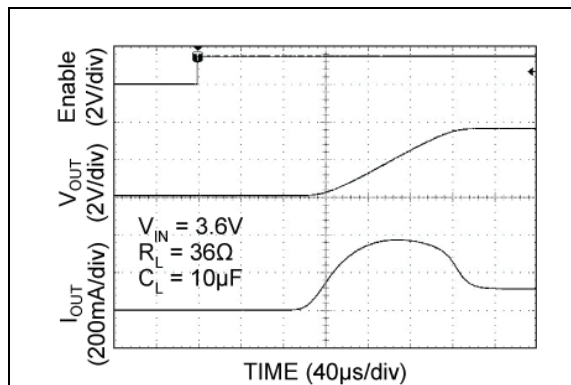


FIGURE 2-36: MIC94042 Turn-On/Turn-Off Timing.

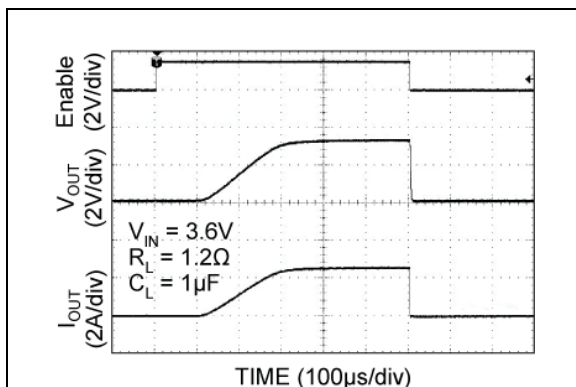


FIGURE 2-37: MIC94042 Turn-On/Turn-Off Timing.

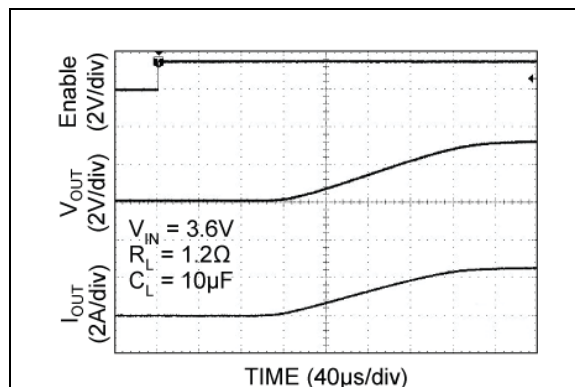


FIGURE 2-40: MIC94042 Turn-On/Turn-Off Timing8.

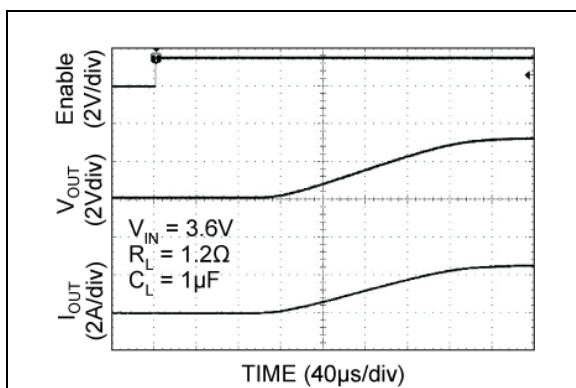


FIGURE 2-38: MIC94042 Turn-On/Turn-Off Timing.

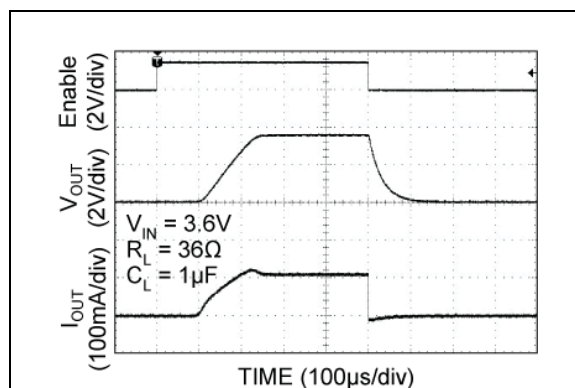


FIGURE 2-41: MIC94043 Turn-On/Turn-Off Timing.

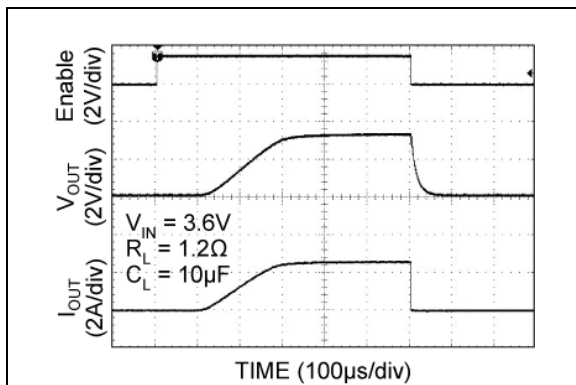


FIGURE 2-39: MIC94042 Turn-On/Turn-Off Timing.

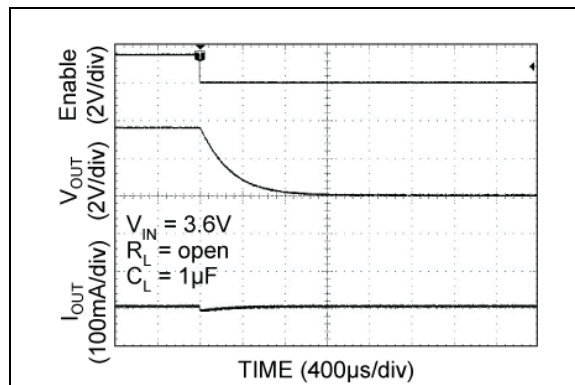


FIGURE 2-42: MIC94043 Turn-On/Turn-Off Timing.

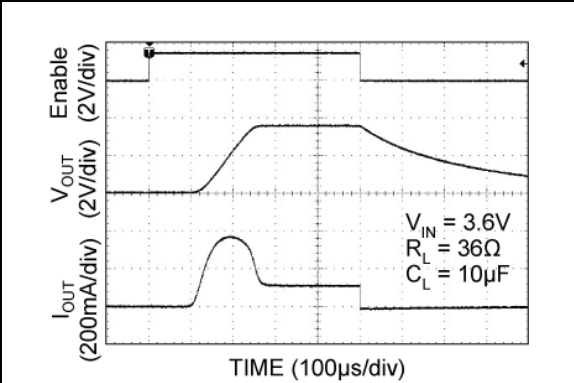


FIGURE 2-43: MIC94043 Turn-On/Turn-Off Timing.

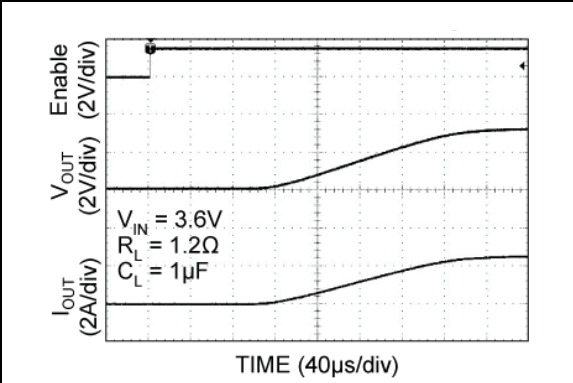


FIGURE 2-46: MIC94043 Turn-On/Turn-Off Timing.

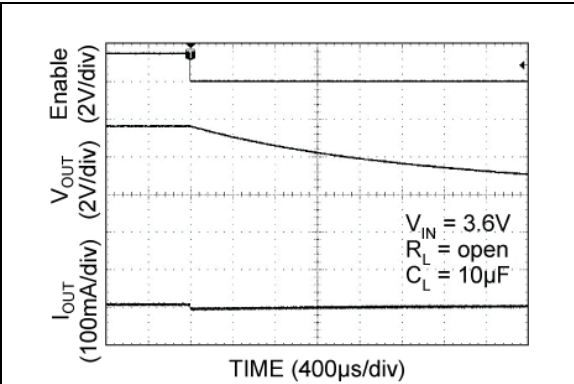


FIGURE 2-44: MIC94043 Turn-On/Turn-Off Timing.

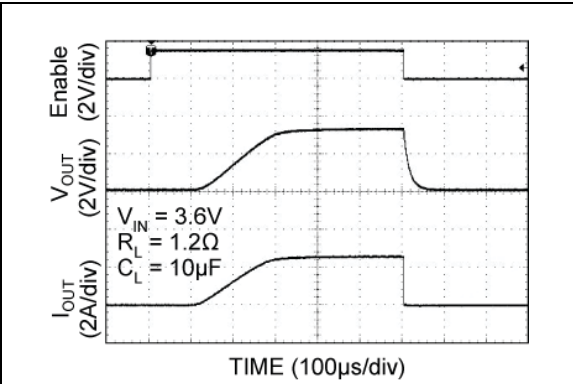


FIGURE 2-47: MIC94043 Turn-On/Turn-Off Timing.

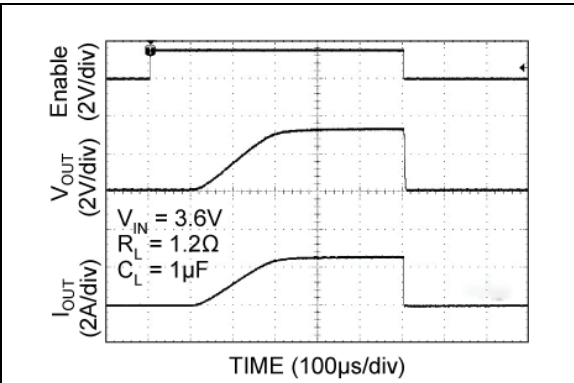


FIGURE 2-45: MIC94043 Turn-On/Turn-Off Timing.

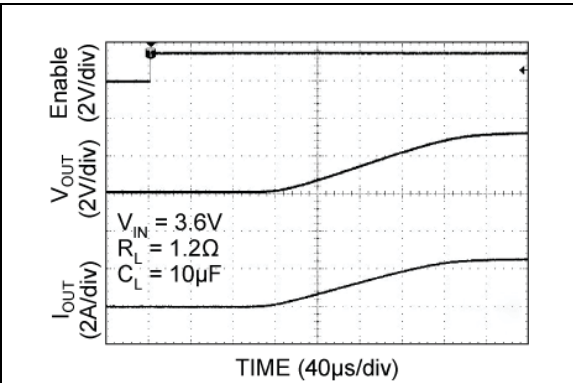


FIGURE 2-48: MIC94043 Turn-On/Turn-Off Timing.

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

TABLE 3-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	V _{OUT}	Drain of P-Channel MOSFET.
2	GND	Ground. Should be connected to electrical ground.
3	V _{IN}	Source of P-Channel MOSFET.
4	EN	Enable (Input): Active-high CMOS/TTL control input for switch. Internal ~2 MΩ pull-down resistor. Output will be off if this pin is left floating.

4.0 APPLICATION INFORMATION

4.1 Power Dissipation Considerations

As with all power switches, the current rating of the switch is limited mostly by the thermal properties of the package and the PCB on which it's mounted. There is a simple Ohm's law type relationship between thermal resistance, power dissipation, and temperature that are analogous to an electrical circuit.

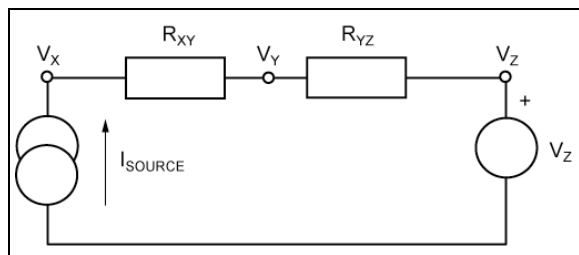


FIGURE 4-1: Simple Electrical Circuit.

From this simple circuit, one can calculate V_X if one knows I_{SOURCE} , V_Z , and the resistor values for R_{XY} and R_{YZ} using Equation 4-1.

EQUATION 4-1:

$$V_X = I_{SOURCE} \times (R_{XY} + R_{YZ}) + V_Z$$

Thermal circuits can be considered using these same rules and can be drawn similarly by replacing current sources with power dissipation (in Watts), resistance with thermal resistance (in $^{\circ}\text{C}/\text{W}$), and voltage sources with temperature (in $^{\circ}\text{C}$).

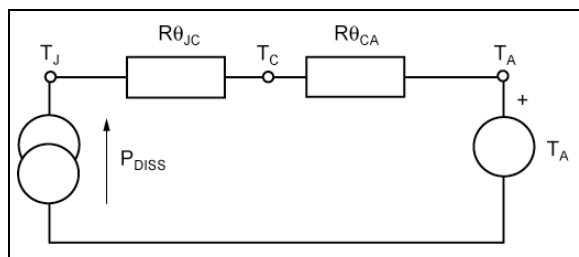


FIGURE 4-2: Simple Thermal Circuit.

By replacing the variables in the equation for V_X , one can find the junction temperature (T_J) from power dissipation, ambient temperature, and then know thermal resistance of the PCB ($R_{\theta_{CA}}$) and the package ($R_{\theta_{JC}}$).

EQUATION 4-2:

$$T_J = P_{DISS} \times (R_{\theta_{JC}} + R_{\theta_{CA}}) + T_A$$

P_{DISS} is calculated as $I_{SWITCH}^2 \times R_{SW(MAX)}$. $R_{\theta_{JC}}$ is found in the [Temperature Specifications](#) section of this data sheet and $R_{\theta_{CA}}$ (the PCB thermal resistance) values for various PCB copper areas is discussed in [Designing with Low Dropout Voltage Regulators](#).

4.1.1 AN EXAMPLE

A switch is intended to drive a 2A load and is placed on a PCB that has a ground plane area of at least 25 mm by 25 mm (625 mm²). The voltage source is a Li-ion battery with a lower operating threshold of 3V and the ambient temperature of the assembly can be up to 50 $^{\circ}\text{C}$.

Summary of variables:

- $I_{SW} = 2\text{A}$
- $V_{IN} = 3\text{V to } 4.2\text{V}$
- $T_A = 50^{\circ}\text{C}$
- $R_{\theta_{JC}} = 90^{\circ}\text{C}/\text{W}$
- $R_{\theta_{CA}} = 53^{\circ}\text{C}/\text{W}$ (as read from [Figure 4-3](#))

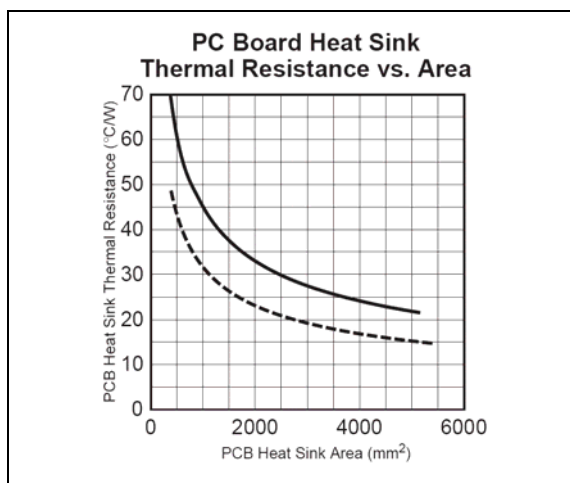


FIGURE 4-3: Excerpt from the LDO Book.

EQUATION 4-3:

$$P_{DISS} = I_{SW}^2 \times R_{SW(MAX)}$$

The worst case switch resistance ($R_{SW(MAX)}$) at the lowest V_{IN} of 3V is not available in the data sheet, so the next lowest value of V_{IN} is used.

$R_{SW(MAX)}$ at 2.5V is 90 mΩ.

If this were a figure for worst case $R_{SW(MAX)}$ for 25°C, an additional consideration is to allow for the maximum junction temperature of 125°C, the actual worst case resistance in this case can be 30% higher (See [Figure 2-1](#)). However, 90 mΩ is the maximum over temperature.

EQUATION 4-4:

$$T_J = 2^2 \times 0.090 \times (90 + 53) + 50 = 101^\circ C$$

This is below the maximum of 125°C.

5.0 PACKAGING INFORMATION

5.1 Package Marking Information

4-Lead UDFN*



Example

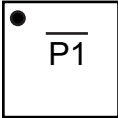


TABLE 5-1: MARKING CODES

Part Number	Marking Code	Features
MIC94040YFL-TR	P4	Fast Turn-On
MIC94041YFL-TR	P1	Fast Turn-On, Load Discharge
MIC94042YFL-TR	P2	Soft-Start
MIC94043YFL-TR	P3	Soft-Start, Load Discharge

Legend: XX...X Product code or customer-specific information
Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code
Ⓔ3 Pb-free JEDEC® designator for Matte Tin (Sn)
* This package is Pb-free. The Pb-free JEDEC designator (Ⓔ3) can be found on the outer packaging for this package.

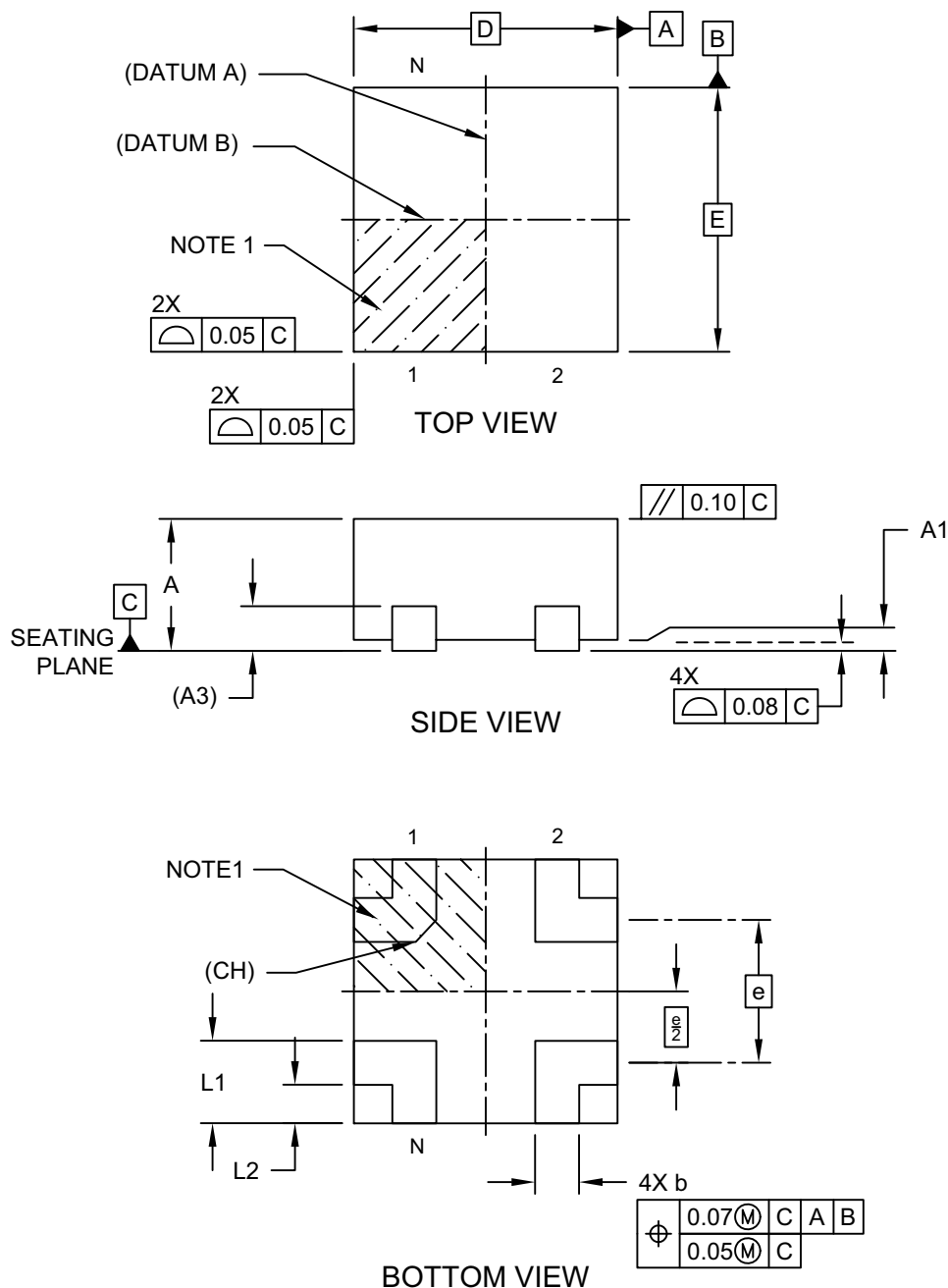
●, ▲, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark).

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.

Underbar (¯) and/or Overbar (˘) symbol may not be to scale.

4-Lead Ultra Thin Plastic Dual Flat, No Lead Package (HEA) - 1.2x1.2x0.6 mm Body [UDFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

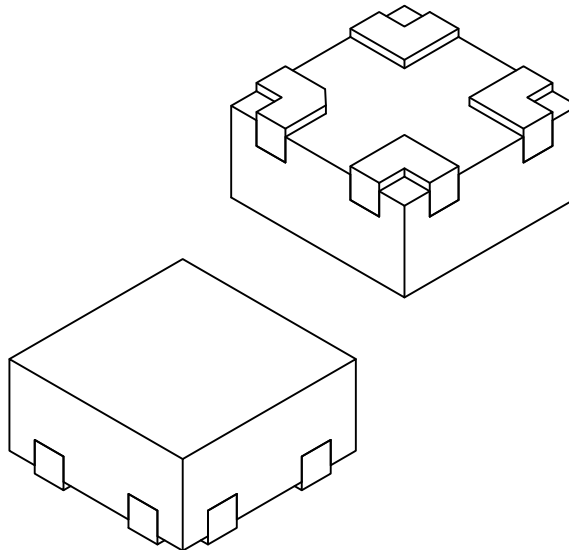


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MIC94040/1/2/3

4-Lead Ultra Thin Plastic Dual Flat, No Lead Package (HEA) - 1.2x1.2x0.6 mm Body [UDFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	4		
Pitch	e	0.65 BSC		
Overall Height	A	0.50	0.55	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.203 REF		
Overall Length	D	1.20 BSC		
Overall Width	E	1.20 BSC		
Terminal Width	b	0.15	0.20	0.25
Terminal Length	L1	0.325	0.375	0.425
Edge to Terminal	L2	0.125	0.175	2.25

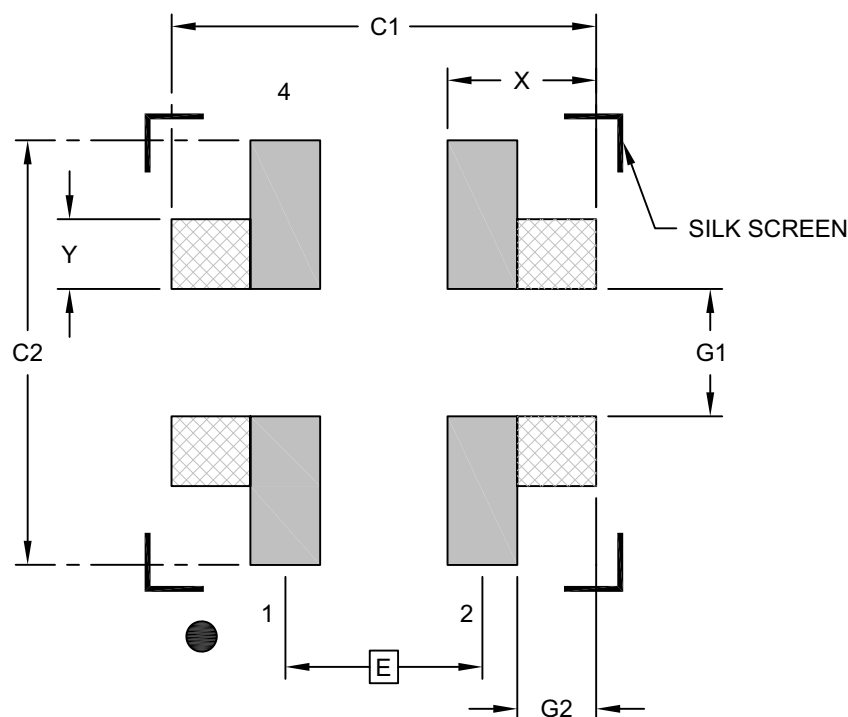
Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1044 Rev A Sheet 2 of 2

4-Lead Ultra Thin Plastic Dual Flat, No Lead Package (HEA) - 1.2x1.2x0.6 mm Body [UDFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Dimension	Units	MILLIMETERS		
	Limits	MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Contact Pad Spacing	C1		1.40	
Contact Pad Spacing	C2		1.40	
Contact Pad Width (X4)	X			0.51
Contact Pad Length (X4)	Y			0.25
Contact Pad to Contact Pad (X4)	G1	0.42		
Edge to Contact Pad (X4)	G2	0.24		

Notes:

- Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-3044 Rev A

APPENDIX A: REVISION HISTORY

Revision B (May 2026)

- Updated the Package Type from FDFN to UDFN throughout the document.
- Updated Package Outline Drawing in [Section 5.0 “Packaging Information”](#).

Revision A (November 2021)

- Converted Micrel document MIC94040/1/2/3 to Microchip data sheet template DS20006607A.
- Minor grammatical text changes throughout.

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

Device	<u>X</u>	<u>XX</u>	<u>-XX</u>	Examples:
Part No.	Junction Temp. Range	Package	Media Type	
Device:	MIC94040:	28 mΩ R _{DS(ON)} 3A High-Side Load Switch with Fast Turn-On		a) MIC94040YFL-TR: MIC94040, -40°C to +125°C Temperature Range, 4-Lead UDFN, 5,000/Reel
	MIC94041:	28 mΩ R _{DS(ON)} 3A High-Side Load Switch with Fast Turn-On and Load Discharge		b) MIC94041YFL-TR: MIC94041, -40°C to +125°C Temperature Range, 4-Lead UDFN, 5,000/Reel
	MIC94042:	28 mΩ R _{DS(ON)} 3A High-Side Load Switch with Soft-Start		c) MIC94042YFL-TR: MIC94042, -40°C to +125°C Temperature Range, 4-Lead UDFN, 5,000/Reel
	MIC94043:	28 mΩ R _{DS(ON)} 3A High-Side Load Switch with Soft-Start and Load Discharge		d) MIC94043YFL-TR: MIC94043, -40°C to +125°C Temperature Range, 4-Lead UDFN, 5,000/Reel
Junction Temperature Range:	Y =	-40°C to +125°C, RoHS-Compliant		Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.
Package:	FL =	4-Lead 1.2 mm x 1.2 mm UDFN		
Media Type:	TR =	5,000/Reel		

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